

C0805C911J2GACTU

Aliases (C0805C911J2GAC7800) SMD Comm C0G, Ceramic, 910 pF, 5%, 200 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
т	0.9mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications Packaging Ta

PackagingT&R, 180mm, Paper TapePackaging Quantity4000

Specifications	
Capacitance	910 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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